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UTILITY PATENT APPLICATION TRANSMITTAL
(Large Entity)*(Only for new nonprovisional applications under 37 CFR 1.53(b))*Docket No.
SAR 13385

Total Pages in this Submission

TO THE ASSISTANT COMMISSIONER FOR PATENTSBox Patent Application
Washington, D.C. 20231

Transmitted herewith for filing under 35 U.S.C. 111(a) and 37 C.F.R. 1.53(b) is a new utility patent application for an invention entitled:

OPTICAL SIGNAL GENERATOR**EL416488746US**

and invented by:

Robert Wayne Paglione
Arye Rosen
Giora Griffel
Stewart Mark PerlowIf a **CONTINUATION APPLICATION**, check appropriate box and supply the requisite information:☐ Continuation ☐ Divisional ☐ Continuation-in-part (CIP) of prior application No.: _____

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Enclosed are:

Application Elements

1. ☒ Filing fee as calculated and transmitted as described below
2. ☒ Specification having 13 pages and including the following:
 - a. ☒ Descriptive Title of the Invention
 - b. ☒ Cross References to Related Applications *(if applicable)*
 - c. ☐ Statement Regarding Federally-sponsored Research/Development *(if applicable)*
 - d. ☐ Reference to Microfiche Appendix *(if applicable)*
 - e. ☒ Background of the Invention
 - f. ☒ Brief Summary of the Invention
 - g. ☒ Brief Description of the Drawings *(if drawings filed)*
 - h. ☒ Detailed Description
 - i. ☒ Claim(s) as Classified Below
 - j. ☒ Abstract of the Disclosure

UTILITY PATENT APPLICATION TRANSMITTAL
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Application Elements (Continued)

3. ☒ Drawing(s) *(when necessary as prescribed by 35 USC 113)*
- a. ☐ Formal Number of Sheets _____
- b. ☒ Informal Number of Sheets 9
4. ☒ Oath or Declaration
- a. ☐ Newly executed *(original or copy)* ☒ Unexecuted
- b. ☐ Copy from a prior application (37 CFR 1.63(d)) *(for continuation/divisional application only)*
- c. ☒ With Power of Attorney ☐ Without Power of Attorney
- d. ☐ DELETION OF INVENTOR(S)
Signed statement attached deleting inventor(s) named in the prior application,
see 37 C.F.R. 1.63(d)(2) and 1.33(b).
5. ☐ Incorporation By Reference *(usable if Box 4b is checked)*
The entire disclosure of the prior application, from which a copy of the oath or declaration is supplied under
Box 4b, is considered as being part of the disclosure of the accompanying application and is hereby
incorporated by reference therein.
6. ☐ Computer Program in Microfiche *(Appendix)*
7. ☐ Nucleotide and/or Amino Acid Sequence Submission *(if applicable, all must be included)*
- a. ☐ Paper Copy
- b. ☐ Computer Readable Copy *(identical to computer copy)*
- c. ☐ Statement Verifying Identical Paper and Computer Readable Copy

Accompanying Application Parts

8. ☒ Assignment Papers *(cover sheet & document(s))*
9. ☐ 37 CFR 3.73(B) Statement *(when there is an assignee)*
10. ☐ English Translation Document *(if applicable)*
11. ☐ Information Disclosure Statement/PTO-1449 ☐ Copies of IDS Citations
12. ☐ Preliminary Amendment
13. ☒ Acknowledgment postcard
14. ☒ Certificate of Mailing
- ☐ First Class ☒ Express Mail *(Specify Label No.):* EL416488746US

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Accompanying Application Parts (Continued)

15. ☐ Certified Copy of Priority Document(s) *(if foreign priority is claimed)*

16. ☐ Additional Enclosures *(please identify below):*

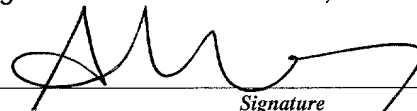
Fee Calculation and Transmittal

CLAIMS AS FILED

For	#Filed	#Allowed	#Extra	Rate	Fee
Total Claims	6	- 20 =	0	x \$18.00	\$0.00
Indep. Claims	3	- 3 =	0	x \$78.00	\$0.00
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					\$0.00
BASIC FEE					\$690.00
OTHER FEE <i>(specify purpose)</i> _____					
TOTAL FILING FEE					\$690.00

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Dated: **7 August 2000**



Signature
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Registration No. 40,656

cc:

CERTIFICATE OF MAILING BY "EXPRESS MAIL" (37 CFR 1.10)Applicant(s): **PAGLIONE, R.W. ET AL.**

Docket No.

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NOT YET KNOWN

Filing Date

HEREWITH

Examiner

NOT YET KNOWN

Group Art Unit

NOT YET KNOWNInvention: **OPTICAL SIGNAL GENERATOR**

I hereby certify that the following correspondence:

NEW UTILITY PATENT APPLICATION*(Identify type of correspondence)*

is being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 in an envelope addressed to: The Assistant Commissioner for Patents, Washington, D.C. 20231 on

7 AUGUST 2000*(Date)***Kimberly Beckett***(Typed or Printed Name of Person Mailing Correspondence)***Kimberly Beckett***(Signature of Person Mailing Correspondence)***EL416488746US***(("Express Mail" Mailing Label Number)***Note: Each paper must have its own certificate of mailing.**

OPTICAL SIGNAL GENERATOR

CROSS REFERENCE TO RELATED APPLICATIONS

The present application claims priority to United States Provisional Application No. 60/147,941, filed August 5, 1999, which is hereby incorporated by reference.

FIELD OF THE INVENTION

The present invention relates to wireless communications systems. More particularly, the present invention relates to a method and apparatus for generating optical signals at high bandwidth.

BACKGROUND OF THE INVENTION

As wireless traffic increases, wireless networks are hard pressed to provide the bandwidth required to keep the traffic flowing efficiently. The increase in traffic has caused carriers to attempt to provide bandwidths as high as a gigabit per second, but at the present, no way exists to provide such a bandwidth over a wireless network.

An example of a known system that provides relatively high bandwidth is provided by a company called Giganet, Inc. Giganet products are known to work typically in the megabits-per-second bandwidth range, but cannot generate a modulated millimeter-wave signal necessary for providing gigabit-per-second throughput.

Thus, the known art lacks ways of providing the throughput necessary for a modern and efficient system.

SUMMARY OF THE INVENTION

To alleviate the problems in the known art, embodiments of the present invention include a gigabit wireless modulator capable of providing data throughput rates that are greater than two orders of magnitude above that of any current commercially-available technology.

In one embodiment of the present invention, an apparatus that optically generates signals is provided for creating modulated millimeter-wave signals. The apparatus includes a mode-locked optical radiation source that generates mode-locked optical radiation with emitted wavelengths separated by approximately 10 GHz to approximately 300 GHz. Connected to the radiation source is an optical demultiplexer with a demultiplexer input, a first demultiplexer output and a second demultiplexer output, the demultiplexer input being coupled to the mode-locked radiation source. In addition, an optical modulator is included, the optical modulator having a modulator input and a modulator output, the modulator input being coupled to the first demultiplexer output. Finally, in this embodiment, an optical multiplexer is included that has a first multiplexer input, a second multiplexer input, and a multiplexer output, the first multiplexer input being coupled to the modulator output, the second multiplexer input being coupled to the second demultiplexer output.

BRIEF DESCRIPTION OF THE DRAWINGS

Figure 1 is a block diagram of a device according to an embodiment of the present invention.

Figure 2 is a block diagram of the functional aspects of a device according to an embodiment of the present invention.

Figure 3 is a schematic drawing of a racetrack laser, according to an embodiment of the present invention.

Figure 4 is a schematic drawing of the epitaxial structure of a racetrack laser, according to an embodiment of the present invention.

Figure 5 shows the schematic diagram of the wafer view shown in cross section taken at the coupling region between the ring and the straight sections, according to one embodiment of the present invention.

Figure 6 displays intensity as a function of current (the L-I curves), according to various embodiments of the present invention.

Figure 7 displays the lasing spectrum of a racetrack laser, according to an embodiment of the present invention.

Figure 8 displays a lasing spectrum of a racetrack laser, according to an embodiment of the present invention.

Figure 9 shows a photograph of a racetrack laser with two saturable absorber sections fabricated in GaAlAs/GaAs QW laser, according to an embodiment of the present invention.

Figure 10 displays the calculated spectrum of a racetrack-laser device, according to an embodiment of the present invention.

DETAILED DESCRIPTION

Embodiments of the present invention provide data-modulated millimeter-wave signals.

Figure 1 is a block diagram of an apparatus according to an embodiment of the present invention. In this figure, mode-locked light source 101 produces light at various wavelengths that are all harmonically related to one another. The mode-locked light source is typically a mode-locked semiconductor laser, examples of which can be found in U.S. Patent No. 6,018,536, filed on February 9, 1999, the entirety of which is hereby incorporated by reference. These mode-locked semiconductor lasers are capable of emitting discrete wavelengths of light separated by a distance on the order of approximately 15nm.

Once the light is emitted, it is coupled into optical demultiplexer 102 that acts as a wavelength filter and separator. In one embodiment, optical demultiplexer 102 can select a first wavelength for a first path, a second wavelength for a second path, and can discard the remaining wavelengths.

Optical modulator 103 can receive the light traveling along the first path, modulate that light with data, and output that light. In one embodiment of the present invention, optical

modulator 103 can be a Mach-Zehnder modulator. In general, optical modulator 103 can be any type of optical modulator that is practicable for the data rates and carrier wavelengths discussed herein.

Optical multiplexer 104 can then receive, in one input, the data-modulated light from the first path, and in another input, the unmodulated light from the second path. This light can be combined and filtered in optical multiplexer 104, and transmitted over a fiber-optic cable to processing electronics 105. Processing electronics 105 can receive the combined signal, and by subtracting one of the signals from the other, can either upconvert or downconvert from the baseband data, thus creating a signal appropriate for transmission over a wireless network. Finally, the data can be passed to transmitter 106 for transmission over a wireless network.

Thus, in one embodiment of the present invention, the mode-locked semiconductor laser produces a mode-locked spectrum of narrow optical wavelengths, with each mode separated by an amount equivalent to a millimeter-wave frequency such as, for example, 0.16 nm or 20 GHz at approximately 1550 nm.

In one embodiment, optical demultiplexer 102 can be, for example, a wavelength division multiplexer (WDM) designed to separate out two of the modes in the spectrum that are, for example, 60 GHz apart. One of the modes can be modulated with high-data-rate (greater than 1Gbps) baseband data, while the other is left unmodulated. Optical multiplexer 104 can also be a WDM, and combines the modulated and unmodulated signals.

Processing electronics 105 can include, in one embodiment of the present invention, a photodiode detector that provides the difference between the two signals. The difference can be, for example, a modulated 60 GHz signal with a bandwidth equal to the baseband data rate. The signal can then be filtered, amplified, and transmitted from a suitable antenna.

Figure 2 is a block diagram of the functional aspects of an embodiment of the present invention. In this figure, the mode-locked laser source 201 produces a mode-locked spectrum of narrow optical wavelengths, each mode separated by an amount equivalent to, for example, a millimeter-wave frequency. For example, but not the only example, the modes can be spaced by approximately .48 nm at 1550 nm, which is equivalent to approximately 60 GHz.

Optical multiplexer 202 can separate out two of the modes in the spectrum. One skilled in the art will appreciate that, while Figure 2 shows optical multiplexer 202 selecting adjacent modes, in practice, the selected modes do not have to be adjacent, as long as the selected modes are appropriately spaced. In one embodiment of the present invention, optical modulator 203 can modulate one of the modes with a data rate that can be a high data rate (e.g., greater than a Gigabit per second), while the other mode is left unmodulated.

Optical multiplexer 204 can combine the modulated and unmodulated signals, and the circuitry 205 can provide the difference between the two signals. The difference can be, in this example approximately 60 GHz with a bandwidth equal to the baseband data rate. The signal can then be filtered, amplified, and transmitted from a suitable antenna. The modulated signal can be received in the customary way, using a receiving antenna and a low-noise downconverter to recover the data.

As discussed above, mode-locked semiconductor laser 101 or 201 can be any type of mode-locked semiconductor laser. For example, mode locked semiconductor laser 101 or 201 can be the mode-locked laser disclosed in U.S. Patent No. 6,018,536. As another example, mode-locked semiconductor laser 101 or 201 can be a semiconductor racetrack laser.

The following discussion describes mode-locked semiconductor racetrack lasers.

Semiconductor ring lasers have attracted considerable attention in the last decade because they provide compact light sources with high spectral purity, but do not require cavity definition by facet etching. As a result, these lasers can be monolithically integrated with other active or passive components to construct composite optical/electronic systems incorporating lasers, amplifiers, passive waveguides and branches, and detectors. The fabrication is relatively simple and cost-effective, and enables large-scale integration. In addition, unlike the simple Fabry-Perot or DFB type lasers, the lithography and the processing involved accurately defines the geometry of the laser cavity and its length. Thus, improved characteristics such as operating wavelength definition and tuning, spectral purity, and pulse repetition rate in mode-locked lasers, as well as concurrent operation of monolithically-integrated laser arrays with different characteristics are possible.

The semiconductor racetrack laser can perform in both a continuous-wave (CW) and single-mode operation, and can be made of materials such as InGaAsP/InP. Passive mode-locked operation in a similar geometry has been demonstrated by incorporating saturable absorbing sections within the laser cavity, and were observed operating at frequencies ranging from 28 GHz to over 100 GHz. Active mode locking in a ring geometry can also be performed with a repetition rate of 9 GHz.

The semiconductor racetrack laser exhibits CW single-mode operation with a side-mode suppression ratio (SMSR) better than 25 dB for a drive current ranging from threshold, at $I_{th} = 73$ mA, to approximately twice the threshold value. In one embodiment of the present invention, the operating wavelength, which is determined by the material system, and to a second extent, by the vertical layered structure, can be $1.598 \mu\text{m}$.

A schematic configuration of the racetrack laser is shown in Figure 3. Several features of this design include the following.

The racetrack geometry:

By using this geometry, as opposed to a circular geometry, the coupling is enhanced from the laser to the straight sections that deliver the light generated inside the resonator to the other parts of the circuit. The straight segments of the racetrack and the straight external channels running in parallel to them form directional couplers with a coupling ratio that depends on the interaction length.

In another embodiment of the present invention, the racetrack geometry can be implemented in an AlGaAs/GaAs material system.

Bi-level etching:

Any known fabrication can be used to make the device. For example, a fabrication method, in which the guiding channels and the racetrack itself are defined by deep mesa etching below the active region or guiding layer, can be used to make the device. Deep etching is required for a strong confinement of the guided light, thereby reducing the bending and scattering loss in the curved sections of the racetracks. Since deep etching results in strong lateral mode confinement, it is necessary to form a very small gap between the ring resonator and the output coupling channels, on the order of $0.1 \mu\text{m}$, to enable sufficient light coupling. This, however,

implies high fabrication tolerance and stringent constraints that tend to prohibit standard lithography and mass production.

To alleviate this problem, an approach can be used in which the deep etching for waveguide definition is performed everywhere except in the coupling region. There, shallow etching is performed to a depth that is sufficient to define the two parallel channels, but is stopped just above the guiding layer to enable a stronger extension of the evanescent field from one channel to the other. As a result, the coupling is enhanced between the racetrack and the output channels, thus eliminating the need to bring the two into close proximity. In addition, this approach provides improved definition of the coupling region. This is shown in Figure 3 by the elevated regions 301 between the racetrack 302 and the straight channels, indicating shallow etching in the coupling regions. By using this fabrication technique, bending and scattering loss in the curved sections of the racetrack, where the etching is deep, is reduced, and at the same time, strong and accurately defined coupling from the racetrack to the other parts of the photonic circuit due to the shallow etching in the coupling regions is maintained.

PROCESSING AND EXPERIMENTAL RESULTS

The schematic drawing of the epitaxial structure is shown in Figure 4, according to one embodiment of the present invention. In this embodiment, three compressively strained InGaAsP quantum wells are imbedded in a 716nm wide waveguide region. The waveguide region also contains a stepped refractive index profile made up of two compositions of InGaAsP, E.g. = 1.13 eV and 1.00 eV. Cladding layers of the InP (E.g. = 1.35 eV) confine the optical mode to the waveguide layer. An InGaAsP etch-stop layer is positioned in the p-cladding layer to set the ridge height in a ridge waveguide laser to a value that will support the fundamental lateral optical mode.

In one embodiment of the present invention, the fabrication process for the ring laser involves a number of steps that are not standard to conventional ridge waveguide laser processing. These steps include liftoff metal deposition of closely spaced lines and both shallow and deep etching with no feature undercutting.

Figure 5 shows the schematic diagram of the wafer view shown in cross section taken at the coupling region between the ring and the straight sections, according to one embodiment of the present invention. In the figure, one can see the bi-level etching on both sides of the guiding channels. This is done by first defining the planar waveguiding geometry using a reactive timed H₂-CH₄ plasma etch to remove the p-cladding layer (InP) down to the upper boundary of the guiding layer. The coupling region is then covered by a second dielectric layer, Si₃N₄.

In one embodiment, racetrack lasers were fabricated with directional couplers having four different lengths: 50 μm , 100 μm , 150 μm , and 200 μm . The L-I curves for these devices are shown in Figure 6, according to various embodiments of the present invention. It is shown that the threshold current for all of the devices is nearly the same, which indicates that the main sources of loss in these lasers are within the resonator itself and could be attributed to wall roughness scattering, bending loss and mode transitions at the boundary between the straight and the curved segments of the resonators. The differential quantum efficiency is significantly better for the 100 μm long coupler.

The threshold current value for the 100 μm long coupler is $I_{th} = 73 \text{ mA}$, which is less than half the value demonstrated previously for InP ring lasers, and comparable to the values obtained for AlGaAs racetrack lasers. The CW spectrum of the racetrack laser with the 100 μm long coupler is shown in Figure 7, according to an embodiment of the present invention. The laser exhibits single-mode operation with a side-mode suppression ratio of better than 26 dB. This characteristic is demonstrated for current levels ranging from threshold to nearly twice the threshold current. As shown in Figure 8, at a drive current of 140mA the spectrum changes abruptly to multi-mode, indicating transition to a self-pulsating passively mode-locked operation.

MODE LOCKING

Racetrack semiconductor lasers are particularly suitable for applying mode-locking techniques. According to an embodiment of the present invention, the generic structure includes incorporating one or two saturable absorbing sections within the laser cavity. For example, Figure 9 shows a photograph of a racetrack laser with two saturable absorber sections fabricated in GaAlAs/GaAs QW laser, according to an embodiment of the present invention. The cavity circumference is 3.1 mm and each of the saturable absorber sections is 50 μm long with 20 μm gap zones between the contacts on each side.

The mode-locking operation can be explained as follows: if all the sections that inject current to the cavity are forward biased, the laser operates in CW mode exhibiting, usually, a single-mode spectrum as shown in Figure 8. If the voltage to the saturable absorber section is reversed and increased, there is a point beyond which the overall gain in a round trip is below threshold and therefore CW operation is prohibited.

A region of operation exists, however, at which there is sufficient gain in the gain section to generate enough photons that are injected into the saturable absorber section and bleach them to saturation via optical pumping. This, momentarily, provides a lasing condition and thus creates a fair amount of photons by stimulated emission that are flushing through the saturable absorber sections. This stream of photons, in turn, will cause stimulated emission within the saturable absorber section that will drain them back to the high-loss state and lasing is again inhibited. The result of this dynamic is viewed in the form of two strong light pulses that propagate clockwise and counterclockwise, respectively, in the cavity. As the front end of each light pulse arrives at a saturable absorber section, it bleaches it and enables the passage of the main part of the pulse which, in turn, causes enough stimulated emission to shut it off behind the pulse until the next time the pulse arrives.

As light is coupled out of the cavity by the directional coupling region, a pulse train with pulse separation equivalent to the cavity round trip time is generated. For example, when the saturable absorber sections of the device shown in Figure 9 were biased at -4V, while the gain section was pumped with an injection current of 190 mA, the laser generated a pulse train with a

periodicity of 40 ps. The calculated spectrum of that device is shown in Figure 10 showing that it exhibits multi-mode-lock operation with a corresponding mode separation of 25 GHz.

The advantages of the racetrack laser structure for generating high-frequency mode-locked signals are apparent. The oscillation frequency is set up by the round trip time that is determined by the optical path length of the laser waveguide cavity. Thus, the pulse frequency can be designed with a high degree of accuracy by the lithography of the device. As it is a monolithic structure it does not rely on an extended cavity configuration with external reflectors and thus the generated signal is less susceptible to acoustical noise. Because no output facets are required, several devices can be monolithically integrated to form a composite system. For example, an array of racetrack lasers, each having different circumferences, together with optical filters for frequency selection, can be manufactured on a single chip to provide a bank of frequencies. A successful demonstration of the system proposed here can set the stage for a monolithic system with all the optical and optoelectronic components required for the RF signal generation manufactured monolithically on a single chip.

The present invention has been described in terms of several embodiments solely for the purpose of illustration. Persons skilled in the art will recognize from this description that the invention is not limited to the embodiments described, but may be practiced with modifications and alterations limited only by the spirit and scope of the appended claims. For example, the invention is not limited to mode-locked lasers both described and incorporated into this specification. Rather, any mode-locked laser that is practicable for the purposes described herein can be used.

What is claimed is:

1. An apparatus for optically generating signals, the apparatus comprising:
 - (a) a mode-locked semiconductor laser that generates mode-locked optical radiation with emitted wavelengths separated by approximately 10 GHz to approximately 300 GHz;
 - (b) an optical demultiplexer with a demultiplexer input, a first demultiplexer output, and a second demultiplexer output, the demultiplexer input being coupled to said mode-locked semiconductor laser;
 - (c) an optical modulator having a modulator input and a modulator output, the modulator input being coupled to the first demultiplexer output; and
 - (d) an optical multiplexer having a first multiplexer input, a second multiplexer input, and a multiplexer output, the first multiplexer input being coupled to the modulator output, the second multiplexer input being coupled to said second demultiplexer output.
2. The apparatus of claim 1, wherein the mode-locked semiconductor laser is a semiconductor racetrack laser.
3. The apparatus of claim 1, wherein the optical modulator is a Mach-Zehnder modulator.
4. The apparatus of claim 1, further including processing electronics coupled to the optical multiplexer output, the processing electronics containing components necessary for downconverting the data signal received from the optical multiplexer.
5. An apparatus for generating optical signals, the apparatus comprising:
 - (a) means for generating mode-locked optical radiation;

- (b) means for separating the generated mode-locked optical radiation into a first signal and a second signal, the first signal and second signal being separated by approximately 60 GHz;
- (c) means for modulating the first signal, thereby creating a modulated signal; and
- (d) means for subtracting the difference between the modulated signal and the second signal.

6. A method for generating an optical signal, the method comprising:

- (a) generating a first mode and a second mode in a mode-locked light source;
- (b) separating the first mode from the second mode;
- (c) modulating the first mode with data;
- (d) combining the second mode with the modulate first mode;
- (e) downconverting the combined second mode and modulated first mode.

An apparatus for optically generating signals comprises a mode-locked optical radiation source that generates mode-locked optical radiation with emitted modes separated by approximately 10 to approximately 300 GHz. Coupled to the optical radiation source is an optical demultiplexer with a demultiplexer input, a first demultiplexer output, and a second demultiplexer output, the demultiplexer input being coupled to said mode-locked radiation source. Additionally, the apparatus comprises an optical modulator having a modulator input and a modulator output, the modulator input being coupled to the first demultiplexer output, and an optical multiplexer having a first multiplexer input, a second multiplexer input, and a multiplexer output, the first multiplexer-input being coupled to the modulator output, the second multiplexer input being coupled to said second demultiplexer output.

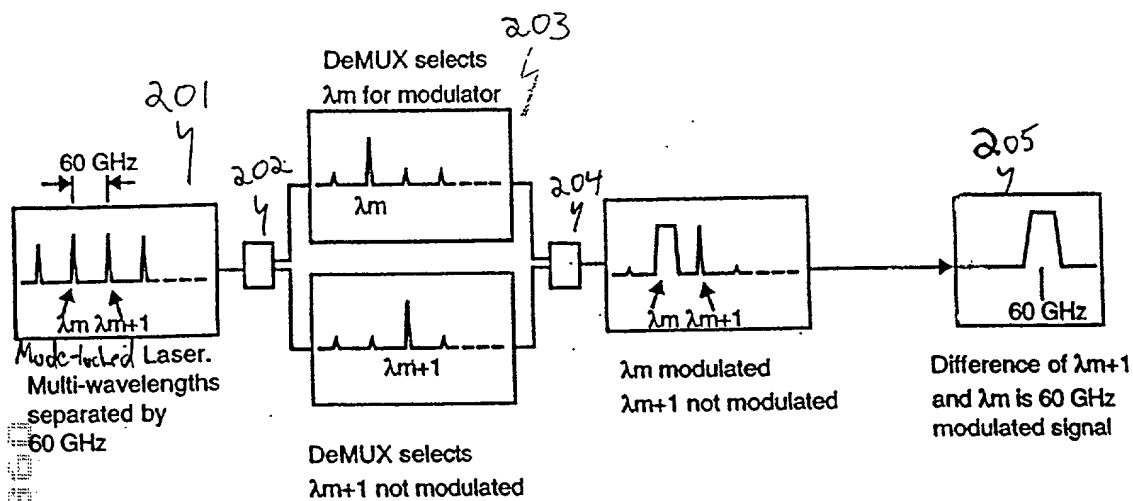
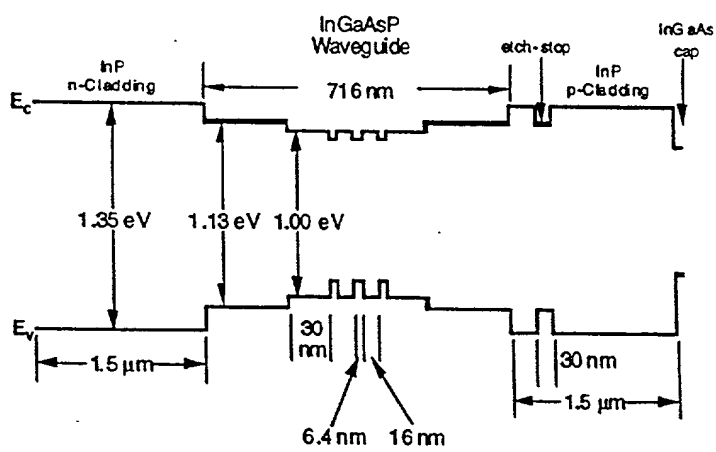


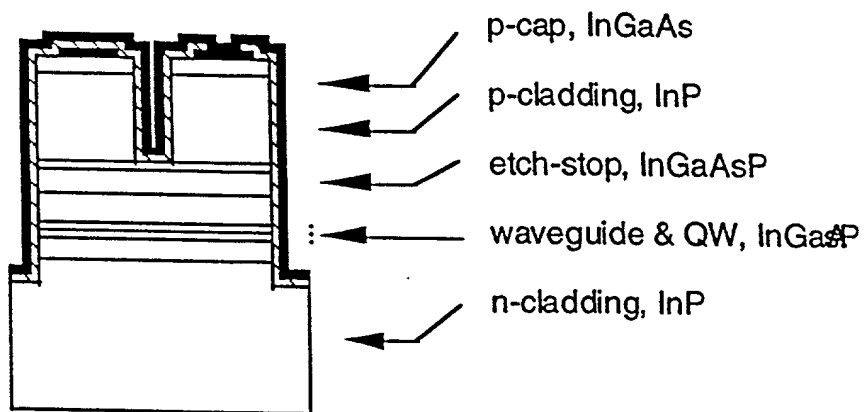
FIGURE 2

FIGURE 3



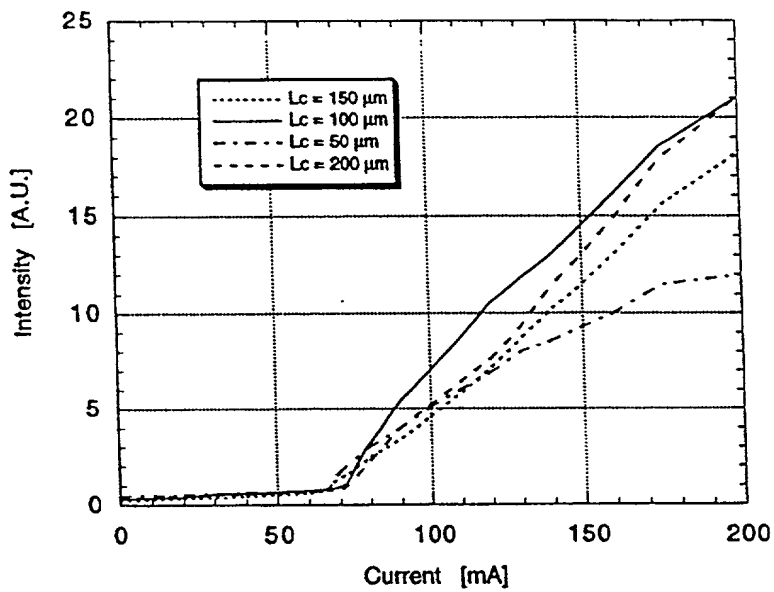
The schematic drawing of the epitaxial structure.

FIGURE 4



A schematic diagram of the wafer view shown in cross section taken from the coupling region between the ring and the straight sections.

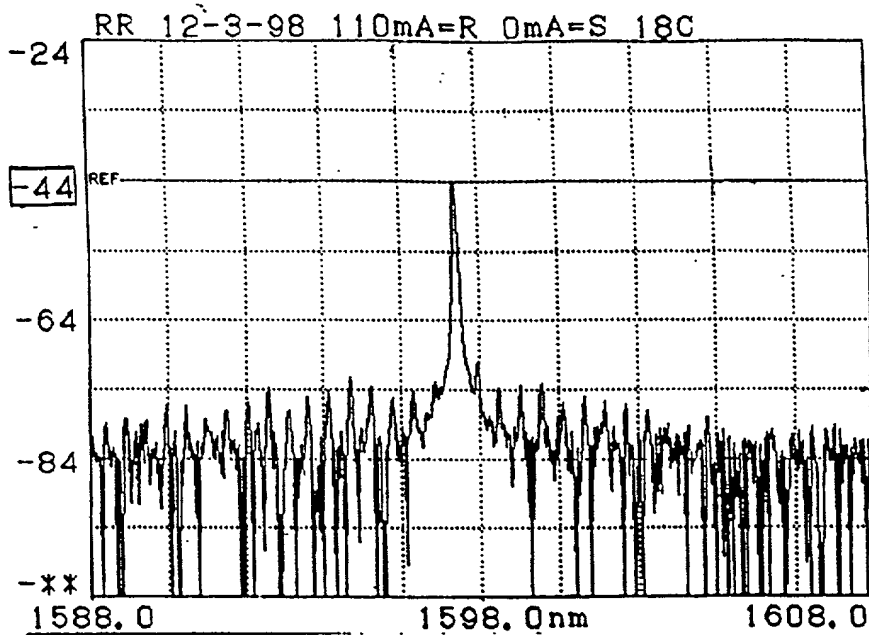
FIGURE 5



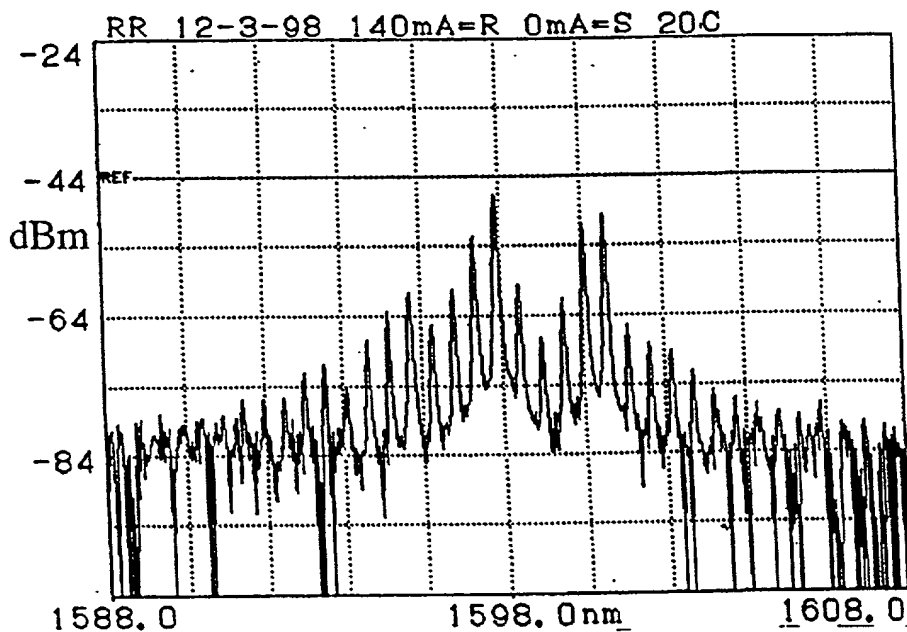
L-I curve for the racetrack laser with a coupling length ranging from 50-200 μm showing nearly the same threshold current for all configurations, but with improved differential efficiency for the 100 μm coupler.

FIGURE 6

FIGURE 7

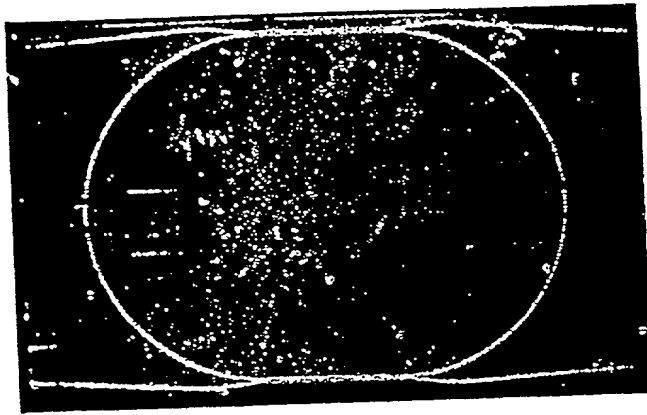


Lasing spectrum of the racetrack laser at a drive current $I = 110$ mA, showing single mode operation with an SMSR = 26 dB. Single-mode operation is maintained from threshold to nearly $2 I_{th}$.



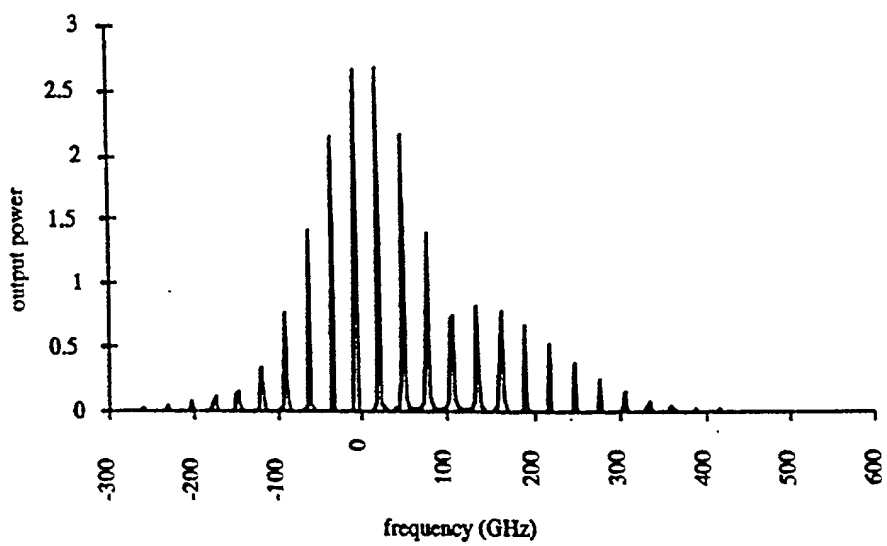
Lasing spectrum at a drive current $I = 140$ mA. An abrupt transition from single-mode (see Fig. 7) to multi-mode operation, apparently due to self-pulsating.

FIGURE 8



Dual-absorber mode-locked racetrack laser fabricated in GaAlAs/GaAs.

FIGURE 9



Computed output spectrum of a passively mode-locked racetrack laser.

FIGURE 10

COMBINED DECLARATION AND POWER OF ATTORNEY

As a below-named inventor, I hereby declare that:

My residence, post office address, and citizenship are as stated below next to my name.

I believe I am the original, first, and sole inventor (if only one name is listed below) or an original, first, and joint inventor (if multiple names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled **OPTICAL SIGNAL GENERATOR**, the specification of which is being filed under the above-identified Attorney Docket Number.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the patentability of this application in accordance with Title 37, Code of Federal Regulations, § 1.56(a).

PRIORITY CLAIM

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed.

_____ (Number)	_____ (Country)	_____ (Day/Month/Year Filed)	____ Yes ____ No (Priority Claimed)
_____ (Number)	_____ (Country)	_____ (Day/Month/Year Filed)	____ Yes ____ No (Priority Claimed)

I hereby claim the benefit under Title 35, United States Code § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, § 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application.

_____ (Application Serial No.)	_____ (Filing Date)	_____ (Status) (patented, pending, abandoned)
_____ (Application Serial No.)	_____ (Filing Date)	_____ (Status) (patented, pending, abandoned)

I hereby claim the benefit under Title 35, United States Code, § 119(e) of any United States provisional application(s) listed below:

PROVISIONAL APPLICATION NUMBER

60/147,941

FILING DATE

5 August 1999

POWER OF ATTORNEY

As a named inventor, I hereby appoint the following attorneys jointly and each of them severally, with full power of substitution, delegation, and revocation, to prosecute this application, to make alterations and amendments therein, to receive the patent, and to transact all business in the Patent and Trademark Office connected therewith:

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DECLARATION

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

SIGNATURES

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